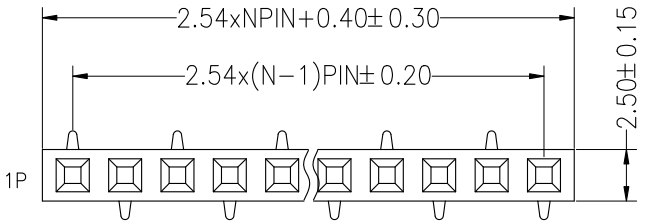
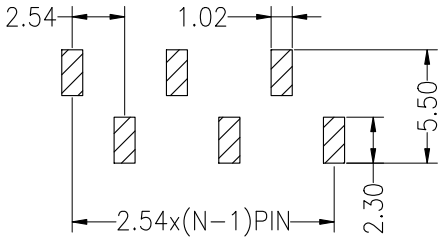
HSF RoHS FILE NO :E362810

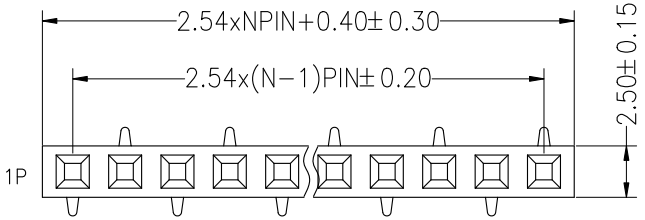
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

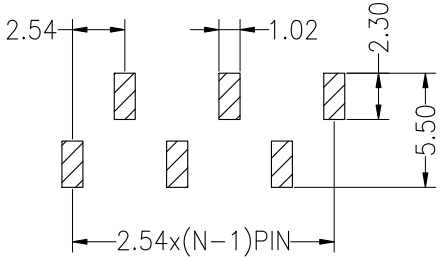
Contact Material:Copper Alloy
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 260°C± 5°C 5S



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)



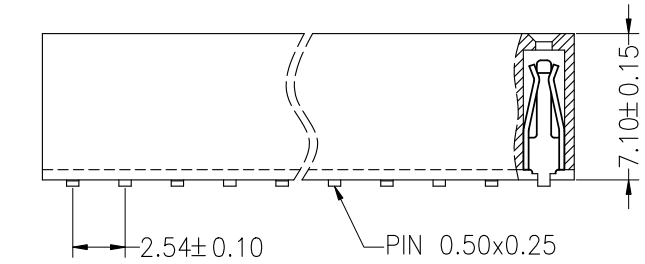


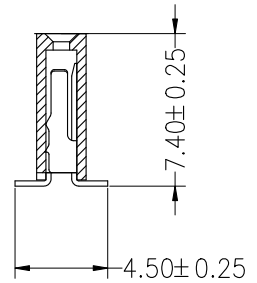


Ordering Information

2271 01 XX X N XX M U X XX

- No.of Pins Per Row: 02~40P
- Insulator Material Option: C=BK−PA6T; E=BK−PA9T; F=BK−LCP
- Contact Plating: G1:Gold Flash; G2:1.5u" Gold; G3:2u" Gold; G4:3u" Gold; G5:5u" Gold; G6:10u" Gold; G7:15u" Gold; G8:30u" Gold; S0:Gold Flash/Tin; SN:Tin
- Packing: 0=PE Bag; A=Tray; T=Tube; P=Tube+Cap; R=Reel+Cap; M=Reel+Mylar
- code stream: 01~99





REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2022.08.10	NEW DRAWING	

OPERATION		DRAW	RICH LIN	22.08.10
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

JILN® 深圳市锦凌电子有限公司
SHENZHEN JINLING ELECTRONICS CO.,LTD
Tel：86-755-27483253 Fax：86-755-2997-5992

PART NO.	227101XXXNXXMUXXX
TITLE:	2.54PF H7.1mm 1xNpin SMT